

Title (en)

METHOD AND DEVICE FOR THE CONTINUOUS PRODUCTION OF ELECTROSLAG-CASTED OR -REMELTED BILLETS

Title (de)

VERFAHREN UND VORRICHTUNG ZUR KONTINUIERLICHEN HERSTELLUNG VON GEGOSSENEN ODER UMGESCHMOLZENEN STRÄNGEN NACH EINEM ELEKTROSCHLACKE-VERFAHREN

Title (fr)

PROCEDE ET DISPOSITIF DE REALISATION EN CONTINU DE TIGES COULEES OU REFONDUES SELON UN PROCEDE SOUS LAITIER ELECTROCONDUCTEUR

Publication

**EP 1187943 A1 20020320 (DE)**

Application

**EP 00929525 A 20000512**

Priority

- AT 100999 A 19990608
- EP 0004290 W 20000512

Abstract (en)

[origin: DE10023098A1] The invention relates to a method and to a device required for carrying out said method for the continuous production of electroslag-casted or remelted billets or ingots from metal, especially from steels and Ni and Co base alloys in a water-cooled ingot mold (10) that is open towards the bottom. The billet (20) that is issued from the bottom of the ingot mold (10) is forced against a guide element (24, 24a) that is stationary with respect to its position to the ingot mold axis (A) by at least one clamping element (26) that is located opposite said guide element in such a manner that the areas of the billet surface that contact the guide or clamping elements (24, 26) change within short time intervals. At least one of those elements is driven to draw the billet while the other elements follow the movement of the billet. The method is also characterized in that at least one of the elements mentioned can be used to establish a contact with a source of current.

IPC 1-7

**C22B 9/18**; **B22D 23/10**

IPC 8 full level

**B22D 11/041** (2006.01); **B22D 11/128** (2006.01); **B22D 23/10** (2006.01); **C22B 9/18** (2006.01); **C22B 9/193** (2006.01)

CPC (source: EP US)

**B22D 23/10** (2013.01 - EP US)

Citation (search report)

See references of WO 0075386A1

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)

**DE 10023098 A1 20001214**; AT 408528 B 20011227; AT A100999 A 20010515; DE 50002922 D1 20030821; EP 1187943 A1 20020320; EP 1187943 B1 20030716; JP 2003501267 A 20030114; JP 4563631 B2 20101013; US 2003111204 A1 20030619; US 6568463 B1 20030527; US 6834707 B2 20041228; WO 0075386 A1 20001214

DOCDB simple family (application)

**DE 10023098 A 20000511**; AT 100999 A 19990608; DE 50002922 T 20000512; EP 0004290 W 20000512; EP 00929525 A 20000512; JP 2001501663 A 20000512; US 34799503 A 20030121; US 98014101 A 20011129